

MAX14808/MAX14809

Octal Three-Level/Quad Five-Level High-Voltage 2A Digital Pulsers with T/R Switch

ABSOLUTE MAXIMUM RATINGS

(All voltages referenced to GND.)

V _{DD} Logic Supply Voltage Range	-0.3V to +5.6V
V _{CC} Positive Driver Supply Voltage Range	-0.3V to +5.6V
V _{EE} Negative Driver Supply Voltage Range	-5.6V to +0.3V
V _{NNA} , V _{NNB} High Negative Supply Voltage Range	-110V to +0.3V
V _{PPA} , V _{PPB} High Positive Supply Voltage Range	-0.3V to +110V
OUT ₋ Output Voltage Range	V _{NN} to V _{PP}
LVOUT ₋ Output Voltage Range (100mA Maximum Current)	-1.2V to +1.2V
DINN ₋ , Dinp ₋ , CC ₋ , SYNC, LDO_EN	-0.3V to +5.6V
CLK, CLK, MODE ₋ Voltage Range	-0.3V to (V _{CC} + 0.3V)

THP Logic Output Voltage Range	-0.3V to +5.6V
V _{GPA} , V _{GPB} Output Voltage Range	max[(V _{PP} - 5.6V), (V _{EE} + 0.6V)] to (V _{PP} + 0.3V)
V _{GNA} , V _{GNB} Output Voltage Range	(V _{NN} - 0.3V) to min[(V _{CC} + 0.6V), (V _{NN} + 5.6V)]
Continuous Power Dissipation (T _A = +70°C)	
TQFN (derate 50mW/°C above +70°C)	4000mW
Operating Temperature Range	-40°C to +85°C
Maximum Junction Temperature	+150°C
Storage Temperature Range	-65°C to +150°C
Lead Temperature (soldering, 10s)	+300°C
Soldering Temperature (reflow)	+260°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

PACKAGE THERMAL CHARACTERISTICS (Note 1)

TQFN

Junction-to-Ambient Thermal Resistance (θ _{JA})	20°C/W	Junction-to-Case Thermal Resistance (θ _{JC})	0.5°C/W
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Note 1: Package thermal resistances were obtained using the method described in JEDEC specification JESD51-7, using a four-layer board. For detailed information on package thermal considerations, refer to www.maximintegrated.com/thermal-tutorial.

DC ELECTRICAL CHARACTERISTICS

(V_{DD} = +3V, V_{CC} = +5V, V_{EE} = -5V, V_{PPA} = +100V, V_{NNA} = -100V, V_{PPB} = +100V, V_{NNB} = -100V, 1μF bypass capacitor between V_{GNA} and V_{NNA}, 1μF bypass capacitor between V_{GNB} and V_{NNB}, 1μF bypass capacitor between V_{GPA} and V_{PPA}, 1μF bypass capacitor between V_{GPB} and V_{PPB}, V_{LDO_EN} = 0V, no load, unless otherwise noted. Typical values are at T_A = +25°C.) (Note 2)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
POWER SUPPLIES (V_{DD}, V_{CC}, V_{EE}, V_{PP}, V_{NN})						
Logic Supply Voltage	V _{DD}		+1.7	+3	+5.25	V
Positive Drive Supply Voltage	V _{CC}		+4.9	+5	+5.1	V
Negative Drive Supply Voltage	V _{EE}		-5.1	-5	-4.9	V
High-Side Supply Voltage	V _{PP}		0		+105	V
Low-Side Supply Voltage	V _{NN}		-105		0	V
External Low-Side LDO Voltage	V _{GN} - V _{NN}	LDO_EN = high	5	5.3	5.5	V
External High-Side LDO Voltage	V _{PP} - V _{GP}	LDO_EN = high	5	5.3	5.5	V
External Floating Power-Supply Current from V _{GN}	I _{VGN}	LDO_EN = high (Note 3)	50			mA
External Floating Power-Supply Current from V _{GP}	I _{VGP}	LDO_EN = high (Note 3)	85			mA
LOGIC INPUTS/OUTPUTS (DINN₋, Dinp₋, MODE₋, SYNC, CC₋, LDO_EN)						
Low-Level Input Threshold	V _{IL}			0.2 x V _{DD}		V
High-Level Input Threshold	V _{IH}		0.8 x V _{DD}			V
Logic Input Capacitance	C _{IN}			4		pF

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DC ELECTRICAL CHARACTERISTICS (continued)

($V_{DD} = +3V$, $V_{CC} = +5V$, $V_{EE} = -5V$, $V_{PPA} = +100V$, $V_{NNA} = -100V$, $V_{PPB} = +100V$, $V_{NNB} = -100V$, $1\mu F$ bypass capacitor between V_{GNA} and V_{NNA} , $1\mu F$ bypass capacitor between V_{GNB} and V_{NNB} , $1\mu F$ bypass capacitor between V_{GPA} and V_{PPA} , $1\mu F$ bypass capacitor between V_{GPB} and V_{PPB} , $V_{LDO_EN} = 0V$, no load, unless otherwise noted. Typical values are at $T_A = +25^\circ C$.) (Note 2)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS	
Logic Input Leakage (All Inputs Except LDO_EN)	I _{IN}	V _{IN} = 0V or V _{DD}		-1	0	+1	μA	
LDO_EN Pulldown Resistance	R _{LDO_EN}			7	10	14	kΩ	
THP Low-Level Output Voltage	V _{OL}	Pullup resistor to V _{DD} (R _{PULLUP} = 1kΩ)		0.1 x V _{DD}			V	
CLOCK INPUTS (CLK, CLK)—DIFFERENTIAL MODE								
Differential Clock Input Voltage Range	V _{CLKD}			0.2		2	V _{P-P}	
Common-Mode Voltage	V _{CLKCM}			V _{CC} /2			V	
Common-Mode Voltage Range	V _{CL}			V _{CC} /2 - 0.45 V _{CC} /2 + 0.45			V	
Input Resistance	R _{CLK} , R _{CLK}	Differential		7			kΩ	
		Common mode		23			kΩ	
Input Capacitance	C _{CLK} , C _{CLK}	Capacitance to GND (each input)		4			pF	
CLOCK INPUTS (CLK, CLK)—SINGLE-ENDED MODE (V _{CLK} < 0.1V)								
Low-Level Input	V _{IL}	CLK		0.2 x V _{DD}			V	
High-Level Input	V _{IH}	CLK		0.8 x V _{DD}			V	
Single-Ended Mode Selection Threshold Low	V _{IL}	CLK		0.1			V	
Single-Ended Mode Selection Threshold High	V _{IH}	CLK		1			V	
Input Capacitance (CLK)	C _{CLK}			4			pF	
Logic Input Leakage (CLK)	I _{CLK}	V _{CLK} = 0V or V _{DD}		-1	0	+1	μA	
Pullup Current (CLK)	I _{CLK}	V _{CLK} = 0V		120			180	μA
SUPPLY CURRENT—SHUTDOWN MODE (MODE0 = Low, MODE1 = Low)								
V _{DD} Supply Current	I _{DD}	All inputs connected to GND or V _{DD}		3			μA	
V _{CC} Supply Current	I _{CC}	All inputs connected to GND or V _{DD}		22			μA	
V _{EE} Supply Current	I _{EE}	All inputs connected to GND or V _{DD}		13			μA	
V _{PP} Supply Current	I _{PP}	All inputs connected to GND or V _{DD}		10			μA	
V _{NN} Supply Current	I _{NN}	All inputs connected to GND or V _{DD}		10			μA	
SUPPLY CURRENT—DISABLE MODE (MODE0 = High, MODE1 = High)								
V _{DD} Supply Current	I _{DDQ}	All inputs connected to GND or V _{DD}	Transparent or single-ended clock mode	1.7	3	μA		
			Differential clock mode, V _{CLKD} = 0.2V	110	190			

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DC ELECTRICAL CHARACTERISTICS (continued)

((V_{DD} = +3V, V_{CC} = +5V, V_{EE} = -5V, V_{PPA} = +100V, V_{NNA} = -100V, V_{PPB} = +100V, V_{NNB} = -100V, 1μF bypass capacitor between V_{GNA} and V_{NNA}, 1μF bypass capacitor between V_{GNB} and V_{NNB}, 1μF bypass capacitor between V_{GPA} and V_{PPA}, 1μF bypass capacitor between V_{GPB} and V_{PPB}, V_{LDO_EN} = 0V, no load, unless otherwise noted. Typical values are at T_A = +25°C.) (Note 2)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
V _{EE} Supply Current	I _{EEQ}	DINN_ = DINP_ = GND			0.26	0.4	mA
		DINN_ = DINP_ =	MAX14808		9.4	13	
		V _{DD}	MAX14809		1.37	2	
V _{CC} Supply Current	I _{CCQ}	DINN_ = DINP_ = GND			0.49	0.75	mA
		DINN_ = DINP_ =	MAX14808		9.6	13.2	
		V _{DD}	MAX14809		1.6	2.3	
V _{CC} Supply Current Increase in Clocked Mode	ΔI _{CC}	Differential clock mode			3.5	5	mA
V _{NN_} Total Supply Current (Quiescent Mode)	I _{NNQ_}	All inputs connected to GND or V _{DD}			195	305	μA
V _{PP_} Total Supply Current (Quiescent Mode)	I _{PPQ_}	All inputs connected to GND or V _{DD}			220	340	μA
Total Power Dissipation per Channel (Disable Mode)	P _{PDIS1}	T/R switch off, damp off (transparent mode)			5.7		mW
	P _{PDIS2}	DINN_ = DINP_ =	MAX14808		17		
		V _{DD}	MAX14809		7		
SUPPLY CURRENT—OCTAL THREE-LEVEL MODE, NO LOAD (MODE0 = High, MODE1 = Low)							
V _{DD} Supply Current (Quiescent Mode)	I _{DD}	All inputs connected to GND or V _{DD}	Transparent or single-ended clock mode		1.7	3	μA
			Differential clock mode, V _{CLKD} = 0.2V		110	190	
V _{EE} Supply Current (Quiescent Mode)	I _{EEQ}	DINN_ = DINP_ = GND			0.26	0.4	mA
		DINN_ = DINP_ =	MAX14808		9.4	13	
		V _{DD}	MAX14809		1.37	2	
V _{CC} Supply Current (Quiescent Mode)	I _{CCQ}	DINN_ = DINP_ = GND			0.49	0.75	mA
		DINN_ = DINP_ =	MAX14808		9.6	13.2	
		V _{DD}	MAX14809		1.6	2.3	
V _{CC} Supply Current Increase in Clocked Mode	ΔI _{CC}	Differential clock mode			3.5	5	mA
V _{NN_} Total Supply Current (Quiescent Mode)	I _{NNQ_}	All inputs connected to GND or V _{DD}			195	305	μA
V _{PP_} Total Supply Current (Quiescent Mode)	I _{PPQ_}	All inputs connected to GND or V _{DD}			220	340	μA

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DC ELECTRICAL CHARACTERISTICS (continued)

($V_{DD} = +3V$, $V_{CC} = +5V$, $V_{EE} = -5V$, $V_{PPA} = +100V$, $V_{NNA} = -100V$, $V_{PPB} = +100V$, $V_{NNB} = -100V$, $1\mu F$ bypass capacitor between V_{GNA} and V_{NNA} , $1\mu F$ bypass capacitor between V_{GNB} and V_{NNB} , $1\mu F$ bypass capacitor between V_{GPA} and V_{PPA} , $1\mu F$ bypass capacitor between V_{GPB} and V_{PPB} , $V_{LDO_EN} = 0V$, no load, unless otherwise noted. Typical values are at $T_A = +25^\circ C$.) (Note 2)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
Total Power Dissipation per Channel (Quiescent Mode)	P _{PDIS1}	T/R switch off, damp off (transparent mode)		5.7		mW	
	P _{PDIS2}	DINN_ = DINP_ = V _{DD} (transparent mode)	MAX14808	17			
			MAX14809	7			
V _{DD} Supply Current	I _{DD1}	CW Doppler (Note 4), transparent or single-ended clock mode		2.2	3.2	mA	
	I _{DD2}	B mode (Note 5), transparent or single-ended clock mode (Figure 1a) (MAX14808)		3.3	6		
		B mode (Note 5), transparent or single-ended clock mode (Figure 1a) (MAX14809)		10	20		
V _{EE} Supply Current	I _{EE1}	8 channels switching, CW Doppler (Note 4)	CC0 = high, CC1 = high	67	92	mA	
	I _{EE2}	8 channels switching, B mode (Note 5) (Figure 1a), CC0 = low, CC1 = low	MAX14808	9.7	14.8		
			MAX14809	2	3		
V _{CC} Supply Current	I _{CC1}	8 channels switching, CW Doppler (Note 4)	CC0 = high, CC1 = high	45	60	mA	
	I _{CC2}	8 channels switching, B mode (Note 5) (Figure 1a), CC0 = low, CC1 = low	MAX14808	10	15		
			MAX14809	2.1	3.2		
V _{DD} Supply Current Increase in Clocked Mode	ΔI _{DD}	Differential clock mode		1.8		mA	
V _{CC} Supply Current Increase in Clocked Mode	ΔI _{CC}	Differential clock mode		3.8		mA	
V _{NN_} Supply Current	I _{NN1}	8 channels switching, CW Doppler, CC0 = high, CC1 = high, R _L = 1kΩ, C _L = 240pF (Note 4)		157	200	mA	
	I _{NN2}	8 channels switching, B mode (Figure 1a), CC0 = low, CC1 = low, R _L = 1kΩ, C _L = 240pF (Note 5)		2	2.8		

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DC ELECTRICAL CHARACTERISTICS (continued)

($V_{DD} = +3V$, $V_{CC} = +5V$, $V_{EE} = -5V$, $V_{PPA} = +100V$, $V_{NNA} = -100V$, $V_{PPB} = +100V$, $V_{NNB} = -100V$, 1 μF bypass capacitor between V_{GNA} and V_{NNA} , 1 μF bypass capacitor between V_{GNB} and V_{NNB} , 1 μF bypass capacitor between V_{GPA} and V_{PPA} , 1 μF bypass capacitor between V_{GPB} and V_{PPB} , $V_{LDO_EN} = 0V$, no load, unless otherwise noted. Typical values are at $T_A = +25^\circ C$.) (Note 2)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
$V_{PP_}$ Supply Current	I_{PP1}	8 channels switching, CW Doppler, CC0 = high, CC1 = high, $R_L = 1k\Omega$, $C_L = 240pF$ (Note 4)			186	230	mA
	I_{PP2}	8 channels switching, B mode (Figure 1a), CC0 = low, CC1 = low, $R_L = 1k\Omega$, $C_L = 240pF$ (Note 5)			3.1	4.5	
Power Dissipation per Channel (Octal Three-Level Mode)	PD_{CW}	1 channel switching, CW Doppler (Note 4)			286		mW
	PD_{PW}	1 channel switching, B mode (Note 5) (Figure 1a), CC0 = low, CC1 = low, $R_L = 1k\Omega$, $C_L = 240pF$	MAX14808		73		
			MAX14809		69.5		
SUPPLY CURRENT—QUAD FIVE-LEVEL DUAL MODE, NO LOAD (MODE0 = Low, MODE1 = High)							
V_{DD} Supply Current (Quiescent Mode)	I_{DDQ}	All inputs connected to GND or V_{DD}	Transparent or single-ended clock mode		1.7	3	μA
			Differential clock mode, $V_{CLKD} = 0.2V$		110	190	
V_{EE} Supply Current (Quiescent Mode)	I_{EEQ}	$DINN_ = DINP_ = GND$			0.26	0.4	mA
		$DINN_ = DINP_ = V_{DD}$	MAX14808		5.4	7.7	
			MAX14809		1.35	2	
V_{CC} Supply Current (Quiescent Mode)	I_{CCQ}	$DINN_ = DINP_ = GND$			0.49	0.75	mA
		$DINN_ = DINP_ = V_{DD}$	MAX14808		5.6	7.8	
			MAX14809		1.6	2.3	
V_{CC} Supply Current Increase	ΔI_{CC}	Differential clock mode			3.5	5	mA
$V_{NN_}$ Supply Current (Quiescent Mode)	$I_{NNQ_}$	All inputs connected to GND or V_{DD}			195	305	μA
$V_{PP_}$ Supply Current (Quiescent Mode)	$I_{PPQ_}$	All inputs connected to GND or V_{DD}			220	340	μA
Power Dissipation per Channel (Quiescent Mode)	P_{DIS1}	T/R switch off, DAMP off (transparent mode)			11.3		mW
	P_{DIS2}	$DINN_ = DINP_ = V_{DD}$ (transparent mode)	MAX14808		24.1		
			MAX14809		14.1		

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DC ELECTRICAL CHARACTERISTICS (continued)

($V_{DD} = +3V$, $V_{CC} = +5V$, $V_{EE} = -5V$, $V_{PPA} = +100V$, $V_{NNA} = -100V$, $V_{PPB} = +100V$, $V_{NNB} = -100V$, $1\mu F$ bypass capacitor between V_{GNA} and V_{NNA} , $1\mu F$ bypass capacitor between V_{GNB} and V_{NNB} , $1\mu F$ bypass capacitor between V_{GPA} and V_{PPA} , $1\mu F$ bypass capacitor between V_{GPB} and V_{PPB} , $V_{LDO_EN} = 0V$, no load, unless otherwise noted. Typical values are at $T_A = +25^\circ C$.) (Note 2)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
V_{DD} Supply Current	I_{DD1}	4 channels switching, CW Doppler (Note 4)			1.4		mA
	I_{DD2}	4 channels switching, B mode (Note 5) (Figure 1a)			4.3		μA
V_{EE} Supply Current	I_{EE1}	4 channels switching, CW Doppler (Note 4)	CC0 = high, CC1 = high		33		mA
	I_{EE2}	4 channels switching, B mode (Note 5) (Figure 1a), CC0 = low, CC1 = low	MAX14808		5.9		
			MAX14809		1.9		
V_{CC} Supply Current	I_{CC1}	4 channels switching, CW Doppler (Note 4)	CC0 = high, CC1 = high		22		mA
	I_{CC2}	4 channels switching, B mode (Note 5) (Figure 1a), CC0 = low, CC1 = low	MAX14808		6		
			MAX14809		2		
V_{DD} Supply Current Increase	ΔI_{DD}	Differential clock mode			1.8		mA
V_{CC} Supply Current Increase	ΔI_{CC}	Differential clock mode			3.8		mA
$V_{NN_}$ Supply Current	I_{NN1}	4 channels switching, CW Doppler (Note 4)	CC0 = high, CC1 = high, $R_L = 1k\Omega$, $C_L = 240pF$		90		mA
	I_{NN2}	4 channels switching, B mode (Note 5) (Figure 1a), CC0 = low, CC1 = low			1.3		
$V_{PP_}$ Supply Current	I_{PP1}	4 channels switching, CW Doppler (Note 4)	CC0 = high, CC1 = high, $R_L = 1k\Omega$, $C_L = 240pF$		103		mA
	I_{PP2}	4 channels switching, B mode (Note 5) (Figure 1a), CC0 = low, CC1 = low			2.2		

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DC ELECTRICAL CHARACTERISTICS (continued)

($V_{DD} = +3V$, $V_{CC} = +5V$, $V_{EE} = -5V$, $V_{PPA} = +100V$, $V_{NNA} = -100V$, $V_{PPB} = +100V$, $V_{NNB} = -100V$, $1\mu F$ bypass capacitor between V_{GNA} and V_{NNA} , $1\mu F$ bypass capacitor between V_{GNB} and V_{NNB} , $1\mu F$ bypass capacitor between V_{GPA} and V_{PPA} , $1\mu F$ bypass capacitor between V_{GPB} and V_{PPB} , $V_{LDO_EN} = 0V$, no load, unless otherwise noted. Typical values are at $T_A = +25^\circ C$.) (Note 2)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
Total Power Dissipation per Channel (Quad Five-Level Dual Mode)	PD _{CW}	1 channel switching, CW Doppler (Note 4), R _L = 1kΩ, C _L = 240pF		311		mW	
	PD _{PW}	1 channel switching, B mode (Note 5) (Figure 1a), CC0 = low, CC1 = low, R _L = 1kΩ, C _L = 240pF	MAX14808	102			
			MAX14809	94.5			
SUPPLY CURRENT—OCTAL THREE-LEVEL, NO LOAD (MODE0 = High, MODE1 = Low, LDO_EN = High, V _{PP_} - V _{GP_} = +5V, V _{GN_} - V _{NN_} = +5V)							
V _{EE} Supply Current (Quiescent Mode)	I _{EEQ_}	All inputs connected to GND		25	46	μA	
V _{CC} Supply Current (Quiescent Mode)	I _{CCQ_}	All inputs connected to GND		280	420	μA	
V _{NN_} Supply Current (Quiescent Mode)	I _{NNQ_}	All inputs connected to GND		40	62	μA	
V _{PP_} Supply Current (Quiescent Mode)	I _{PPQ_}	All inputs connected to GND		40	62	μA	
OUTPUT STAGE							
V _{NNA} , V _{NNB} Connected Low-Side Output Impedance	R _{OLS}	I _{OUT_} = -50mA	CC0 = low, CC1 = low	8.5		Ω	
			CC0 = high, CC1 = low	10			
			CC0 = low, CC1 = high	13.5			
			CC0 = high, CC1 = high	26	48		
V _{PPA} , V _{PPB} Connected High-Side Output Impedance	R _{OHS}	I _{OUT_} = +50mA	CC0 = low, CC1 = low	9		Ω	
			CC0 = high, CC1 = low	10.5			
			CC0 = low, CC1 = high	14.5			
			CC0 = high, CC1 = high	27	53		
Clamp nFET Output Impedance	R _{ONG}	I _{OUT_} = -50mA,		13.5		Ω	
Clamp pFET Output Impedance	R _{OPG}	I _{OUT_} = +50mA		13.5		Ω	
Active Damp Output Impedance	R _{DAMP}	Before grass-clipping diode		500		Ω	

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DC ELECTRICAL CHARACTERISTICS (continued)

($V_{DD} = +3V$, $V_{CC} = +5V$, $V_{EE} = -5V$, $V_{PPA} = +100V$, $V_{NNA} = -100V$, $V_{PPB} = +100V$, $V_{NNB} = -100V$, $1\mu F$ bypass capacitor between V_{GNA} and V_{NNA} , $1\mu F$ bypass capacitor between V_{GNB} and V_{NNB} , $1\mu F$ bypass capacitor between V_{GPA} and V_{PPA} , $1\mu F$ bypass capacitor between V_{GPB} and V_{PPB} , $V_{LDO_EN} = 0V$, no load, unless otherwise noted. Typical values are at $T_A = +25^\circ C$.) (Note 2)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
V_{NNA} , V_{NNB} Connected Low-Side Output Current	I_{OLS}	$V_{DS} = +100V$	CC0 = low, CC1 = low	2.0		A
			CC0 = high, CC1 = low	1.5		
			CC0 = low, CC1 = high	1.0		
			CC0 = high, CC1 = high	0.5		
V_{PPA} , V_{PPB} Connected High-Side Output Current	I_{OHS}	$V_{DS} = +100V$	CC0 = low, CC1 = low	2.0		A
			CC0 = high, CC1 = low	1.5		
			CC0 = low, CC1 = high	1.0		
			CC0 = high, CC1 = high	0.5		
GND-Connected nFET Output Current	I_{ONG}	$V_{DS} = +100V$		1		A
GND-Connected pFET Output Current	I_{OPG}	$V_{DS} = +100V$		1		A
Diode Voltage Drop (Blocking Diode and Grass-Clipping Diode)	V_{DROP}	$I_{OUT_} = \pm 50mA$		1.7		V
LVOUT_Diode Clamping Voltage	LV_{CLAMP}	$I_{LOAD} = 1mA$ (MAX14808 only)	-0.9		+1	V
Grass-Clipping Diode Reverse Capacitance	C_{REV}			2.5		pF
OUT_ Equivalent Large-Signal Shunt Capacitance	C_{HS}	200V _{P-P} signal		80		pF
T/R Switch On Impedance	R_{ON}	MAX14808 only		11.5		Ω
T/R Switch Off Impedance	R_{OFF}	MAX14808 only	1			M Ω
LVOUT_ Output Offset	LV_{OFF}	LVOUT_, OUT_ unconnected, $V_{CC} = +5V$, $V_{EE} = -5V$	-40	0	+40	mV
THERMAL SHUTDOWN						
Thermal-Shutdown Threshold	t_{SDN}	Temperature rising		+145		$^\circ C$
Thermal-Shutdown Hysteresis	t_{HYS}			20		$^\circ C$

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AC ELECTRICAL CHARACTERISTICS

($V_{DD} = +3V$, $V_{CC} = +5V$, $V_{EE} = -5V$, $V_{PPA} = +100V$, $V_{NNA} = -100V$, $V_{PPB} = +100V$, $V_{NNB} = -100V$, V_{GNA} connected to V_{NNA} with $1\mu F$ capacitor, V_{GNB} connected to V_{NNB} with $1\mu F$ capacitor, V_{GPA} connected to V_{PPA} with $1\mu F$ capacitor, V_{GPB} connected to V_{PPB} with $1\mu F$ capacitor, $V_{\overline{LDO_EN}} = 0V$, $V_{CC0} = 0V$, $V_{CC1} = 0V$, $R_L = 1k\Omega$, $C_L = 240pF$, unless otherwise noted. Typical values are at $T_A = +25^\circ C$.) (Note 2)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
Logic Input to Output Rise Propagation Delay	t_{PLH}	From 50% DINP_/DINN_ (transparent mode) to 10% OUT_ transition swing (Figure 2a)			18		ns
Logic Input to Output Fall Propagation Delay	t_{PHL}	From 50% DINP_/DINN_ (transparent mode) to 10% OUT_ transition swing (Figure 2a)			18		ns
Logic Input to Output Rise to GND Propagation Delay	t_{PLO}	From 50% DINP_/DINN_ (transparent mode) to 10% OUT_ transition swing (Figure 2a)			18		ns
Logic Input to Output Fall to GND Propagation Delay	t_{PHO}	From 50% DINP_/DINN_ (transparent mode) to 10% OUT_ transition swing (Figure 2a)			18		ns
OUT_ Fall Time (V_{PPA} to V_{NNA} , V_{PPB} to V_{NNB})	t_{FPN}	Figure 2b			30	48	ns
OUT_ Rise Time (V_{NNA} to V_{PPA} , V_{NNB} to V_{PPB})	t_{RNP}	Figure 2b			30	48	ns
OUT_ Rise Time (GND to V_{PPA} , GND to V_{PPB})	t_{ROP}	Figure 2b			15	22.5	ns
OUT_ Fall Time (GND to V_{NNA} , GND to V_{NNB})	t_{FON}	Figure 2b			15	22.5	ns
OUT_ Rise Time (V_{NNA} to GND, V_{NNB} to GND)	t_{RNO}	20% to 80% transition (Figure 2b)	Three-level mode		21		ns
			Five-level dual mode		13		
OUT_ Fall Time (V_{PPA} to GND, V_{PPB} to GND)	t_{FPO}	20% to 80% transition (Figure 2b)	Three-level mode		21		ns
			Five-level dual mode		13		
T/R Switch Turn-On Time	t_{ONTRSW}	(MAX14808 only) Figure 3			0.65	1.2	μs
T/R Switch Turn-Off Time	$t_{OFFTRSW}$	(MAX14808 only) Figure 3 (Note 6)			0.02	0.1	μs
Output Enable Time (Shutdown Mode to Normal Operation)	t_{EN1}					100	μs
Output Disable Time (Normal Operation to Shutdown Mode)	t_{DIS1}					10	μs

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Octal Three-Level/Quad Five-Level High-Voltage 2A Digital Pulsers with T/R Switch

AC ELECTRICAL CHARACTERISTICS (continued)

($V_{DD} = +3V$, $V_{CC} = +5V$, $V_{EE} = -5V$, $V_{PPA} = +100V$, $V_{NNA} = -100V$, $V_{PPB} = +100V$, $V_{NNB} = -100V$, V_{GNA} connected to V_{NNA} with $1\mu F$ capacitor, V_{GNB} connected to V_{NNB} with $1\mu F$ capacitor, V_{GPA} connected to V_{PPA} with $1\mu F$ capacitor, V_{GPB} connected to V_{PPB} with $1\mu F$ capacitor, $V_{\overline{LDO_EN}} = 0V$, $V_{CC0} = 0V$, $V_{CC1} = 0V$, $R_L = 1k\Omega$, $C_L = 240pF$, unless otherwise noted. Typical values are at $T_A = +25^\circ C$.) (Note 2)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Output Enable Time (Transmit Disable Mode to Normal Operation)	t_{EN2}				50	ns
Output Disable Time (Normal Operation to Transmit Disable Mode)	t_{DIS2}				65	ns
Output Enable Time (Normal Operation to Sync Mode)	t_{EN3}				4	μs
Output Disable Time (Sync Mode to Normal Operation)	t_{DIS3}				500	ns
CLK Frequency	f_{CLK}	$V_{DD} = 2.5V$			200	MHz
Input Setup Time (DINN_, DINP_)	t_{SETUP}	$V_{DD} = 2.5V$	2			NS
Input Hold Time (DINN_, DINP_)	t_{HOLD}	$V_{DD} = 2.5V$	0.5			ns
Second-Harmonic Distortion (Low Voltage)	THD2LV	$f_{OUT_} = 5MHz$, $V_{PPA} = -V_{NNA} = +5V$, $V_{PPB} = -V_{NNB} = +5V$, square wave (all modes)		-40		dBc
Second-Harmonic Distortion (High Voltage)	THD2HV	$f_{OUT_} = 5MHz$, $V_{PPA} = -V_{NNA} = +100V$, $V_{PPB} = -V_{NNB} = +100V$, square wave (all modes)		-43		dBc
Pulse Cancellation	PC1	$f_{OUT_} = 5MHz$, $V_{PPA} = -V_{NNA} = +100V$, $V_{PPB} = -V_{NNB} = +100V$, 2 periods, all harmonics of the summed signal with respect to the carrier		-40		dBc
	PC2	$f_{OUT_} = 5MHz$, $V_{PPA} = -V_{NNA} = +100V$, $V_{PPB} = -V_{NNB} = +100V$, 2 periods, $[(V_0 + V_{180})_{RMS}/(2 \times V_{0RMS})]_{dB}$		-40		
Pulser Bandwidth	BW	$V_{PP} = +60V$, $V_{NNA} = -60V$ (Figure 4)		20		MHz
RMS Output Jitter	t_j	$f_{OUT_} = 5MHz$, $V_{PPA} = -V_{NNA} = +5V$, $V_{PPB} = -V_{NNB} = +5V$, both in clocked mode or transparent mode (Figure 5)		6.25		ps

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Octal Three-Level/Quad Five-Level High-Voltage 2A Digital Pulsers with T/R Switch

AC ELECTRICAL CHARACTERISTICS (continued)

($V_{DD} = +3V$, $V_{CC} = +5V$, $V_{EE} = -5V$, $V_{PPA} = +100V$, $V_{NNA} = -100V$, $V_{PPB} = +100V$, $V_{NNB} = -100V$, V_{GNA} connected to V_{NNA} with $1\mu F$ capacitor, V_{GNB} connected to V_{NNB} with $1\mu F$ capacitor, V_{GPA} connected to V_{PPA} with $1\mu F$ capacitor, V_{GPB} connected to V_{PPB} with $1\mu F$ capacitor, $V_{LDO_EN} = 0V$, $V_{CC0} = 0V$, $V_{CC1} = 0V$, $R_L = 1k\Omega$, $C_L = 240pF$, unless otherwise noted. Typical values are at $T_A = +25^\circ C$.) (Note 2)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
T/R Switch Harmonic Distortion (MAX14808)	THD _{TRSW}	$R_{LOAD} = 200\Omega$, $V_{SIGNAL} = 100mV_{P-P}$		-50		dB
T/R Switch Turn-On/Off Voltage Spike (MAX14808)	V_{SPIKE}	$R_{LOAD} = 1k\Omega$ at both sides of T/R switch		50		mV
Crosstalk	CT	$f = 5MHz$, adjacent channels, $R_{LOUT_} = 200\Omega$		-51		dB

Note 2: All devices are 100% production tested at $T_A = +85^\circ C$. Limits over the operating temperature range are guaranteed by design.

Note 3: Maximum operating current from $V_{GN_}$ and $V_{GP_}$ external power sources can vary depending on application requirements. The suggested minimum values assume 8 channels running in continuous transmission (CWD) at 5MHz with $CC0 = CC1 = high$.

Note 4: CW Doppler: continuous wave, $f = 5MHz$, $V_{DD} = +3V$, $V_{CC} = -V_{EE} = +5V$, $V_{PP_} = -V_{NN_} = +5V$.

Note 5: B mode: $f = 5MHz$, PRF = 5kHz, 1 period, $V_{DD} = +3V$, $V_{CC} = -V_{EE} = +5V$, $V_{PP_} = -V_{NN_} = +100V$.

Note 6: T/R switch turn-off time is the time required to switch off the bias current of the T/R switch. The off-isolation is not guaranteed.

Timing Diagrams

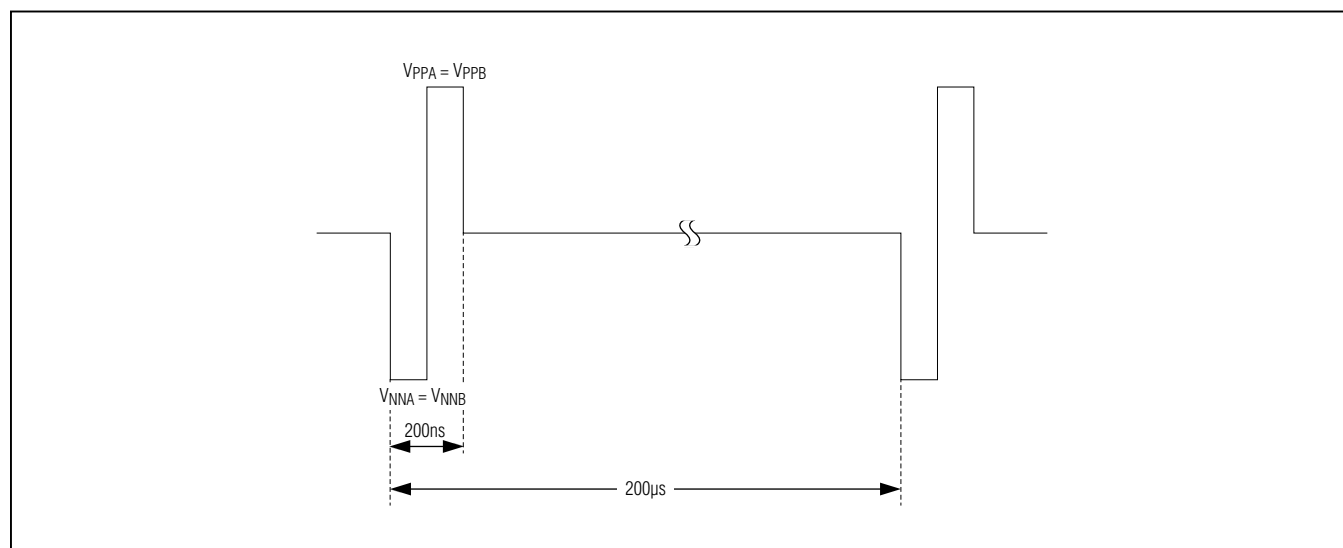


Figure 1a. High-Voltage Burst Test (Three Levels)

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Octal Three-Level/Quad Five-Level High-Voltage 2A Digital Pulsers with T/R Switch

Timing Diagrams (continued)

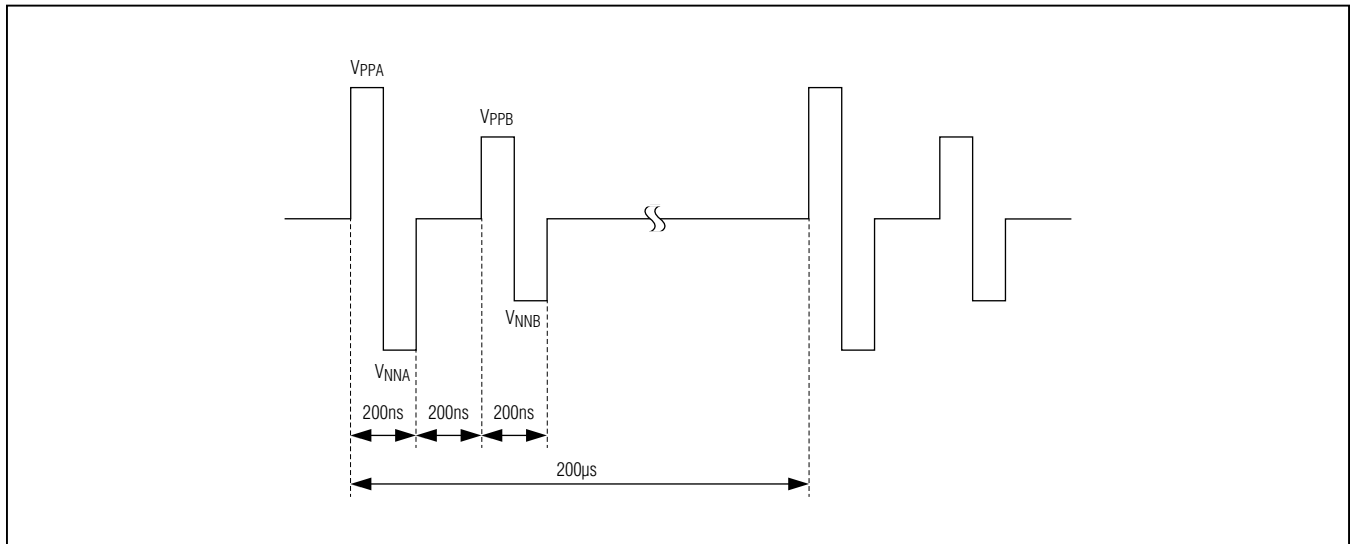


Figure 1b. High-Voltage Burst Test (Five Levels)

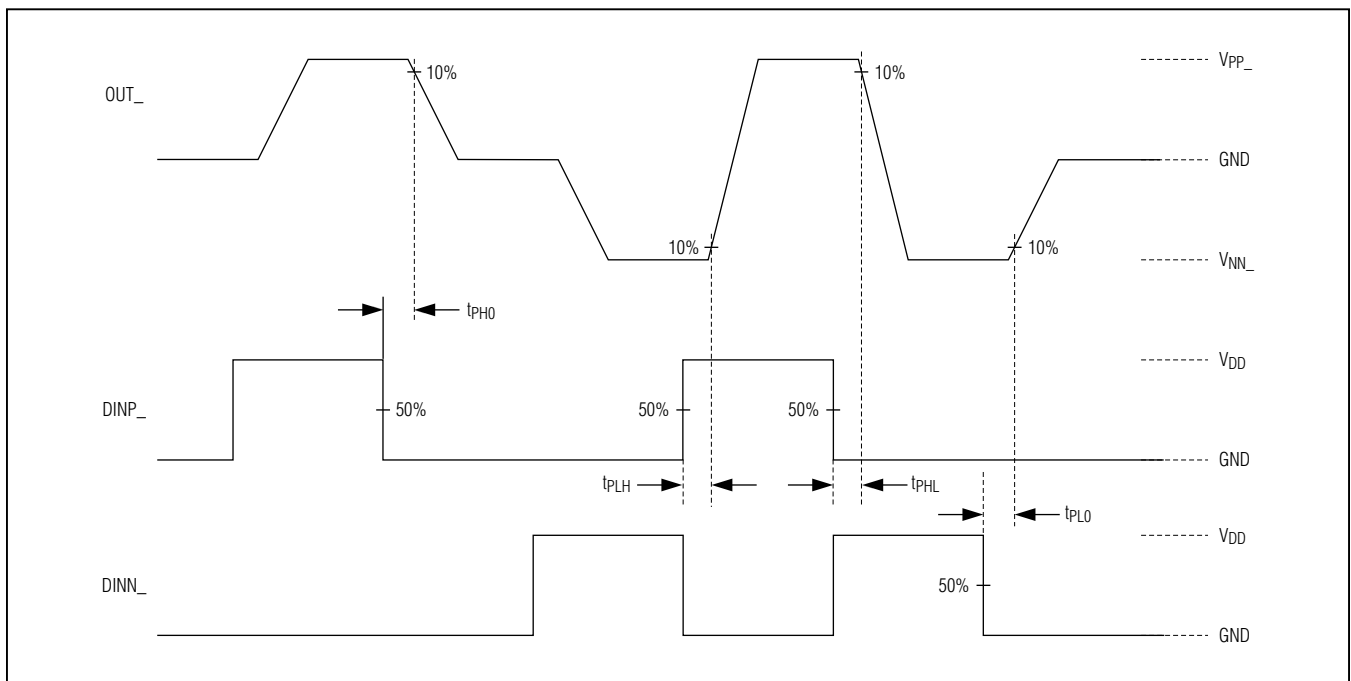


Figure 2a. Propagation Delay Timing

Octal Three-Level/Quad Five-Level High-Voltage 2A Digital Pulsers with T/R Switch

Timing Diagrams (continued)

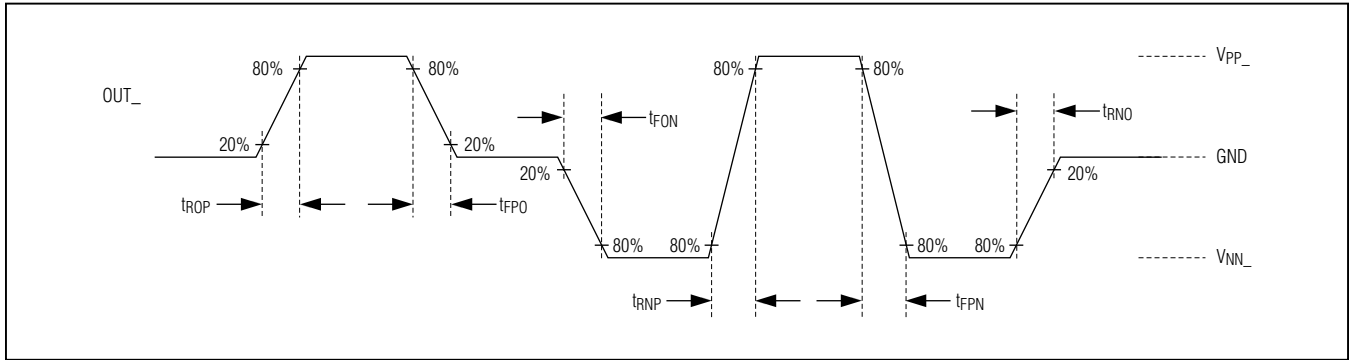


Figure 2b. Output Rise/Fall Timing

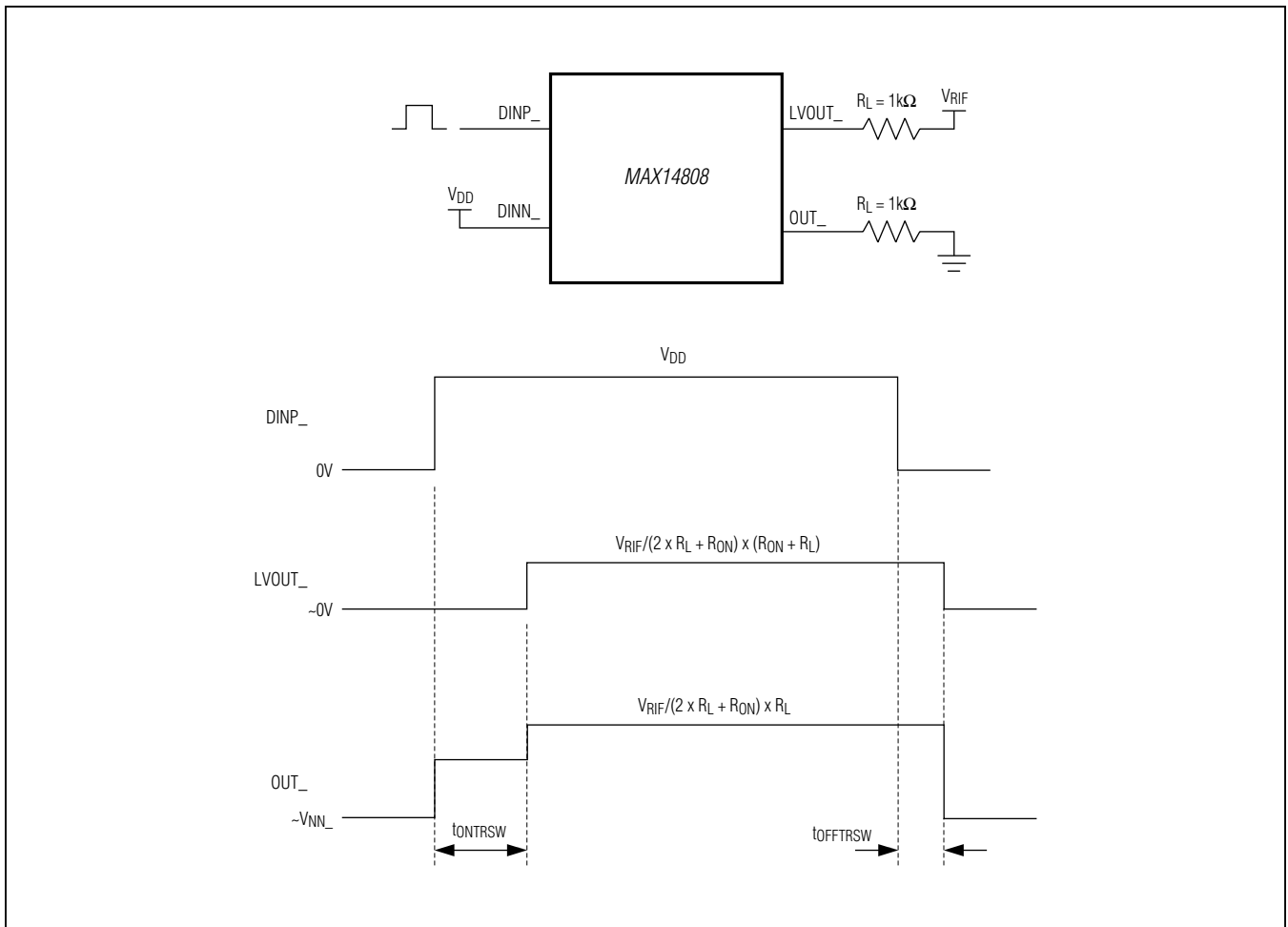


Figure 3. T/R Switch Turn-On/Off Time

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Octal Three-Level/Quad Five-Level High-Voltage 2A Digital Pulsers with T/R Switch

Timing Diagrams (continued)

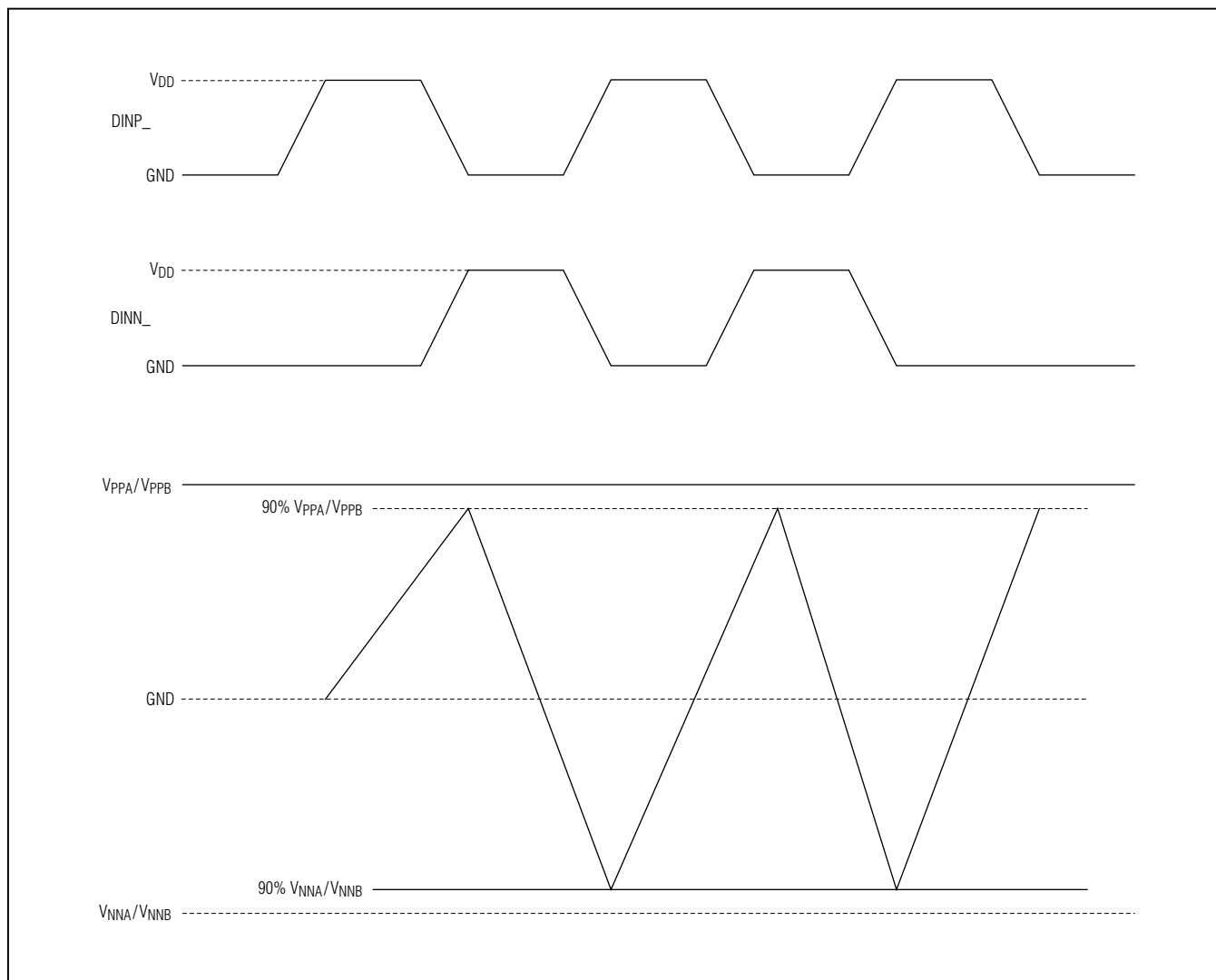


Figure 4. Bandwidth

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Octal Three-Level/Quad Five-Level High-Voltage 2A Digital Pulsers with T/R Switch

Timing Diagrams (continued)

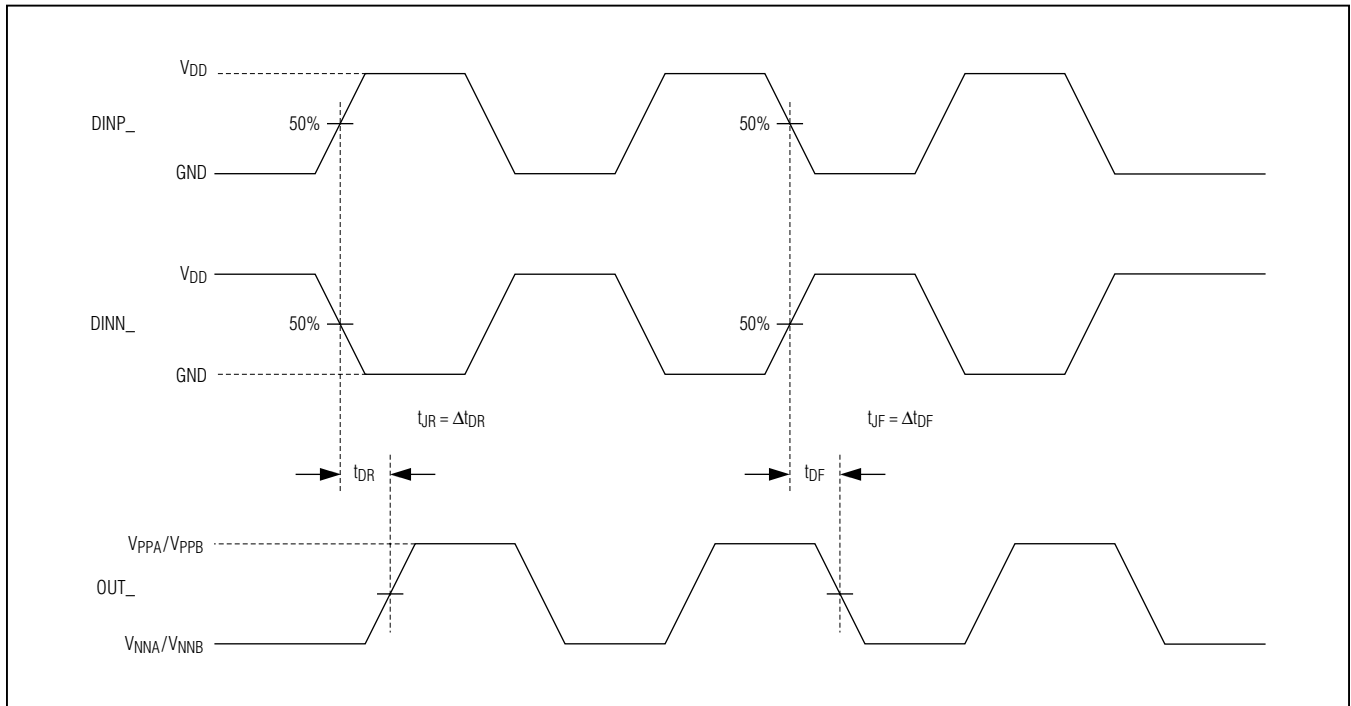
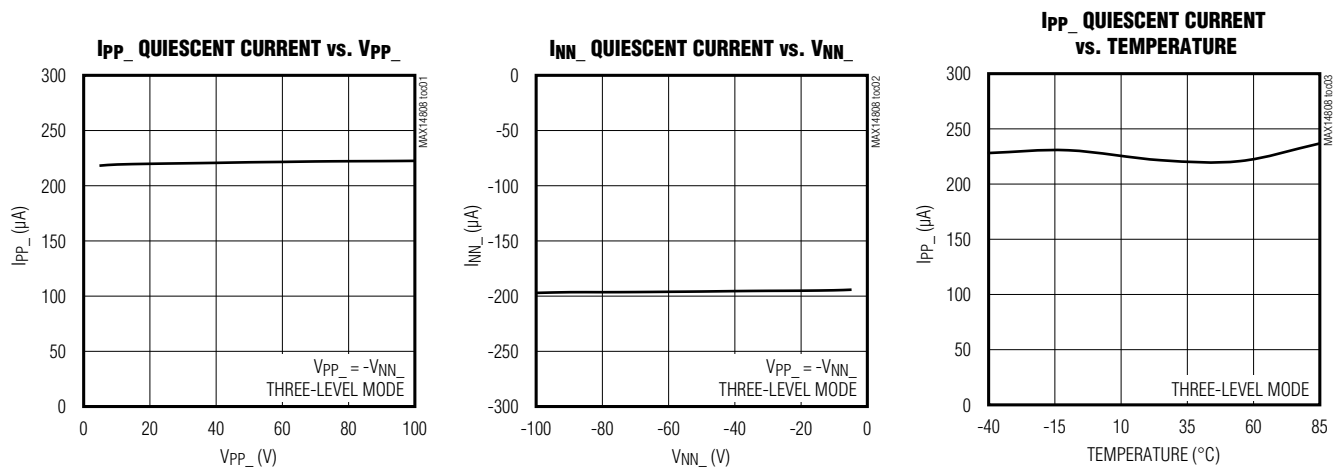


Figure 5. Jitter Timing

Typical Operating Characteristics

($V_{DD} = +5V$, $V_{CC} = +5V$, $V_{EE} = -5V$, $V_{PP_-} = +100V$, $V_{NN_-} = -100V$, $R_L = 1k\Omega$, $C_L = 240pF$, unless otherwise noted. Typical values are at $T_A = +25^\circ C$.)

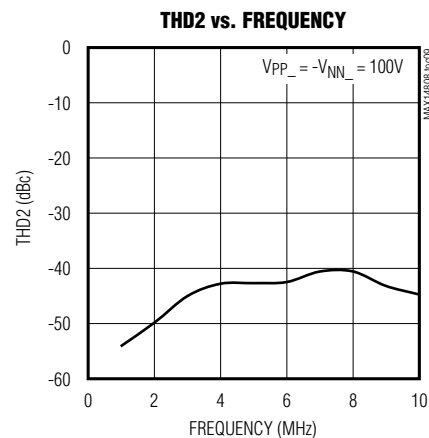
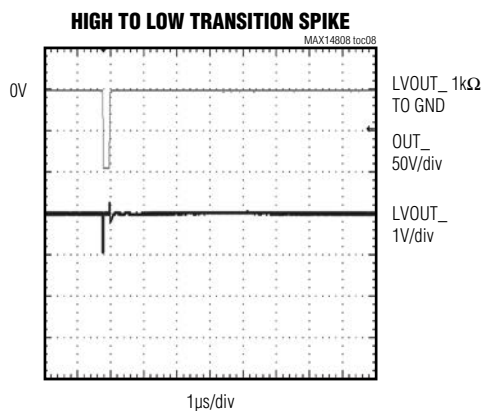
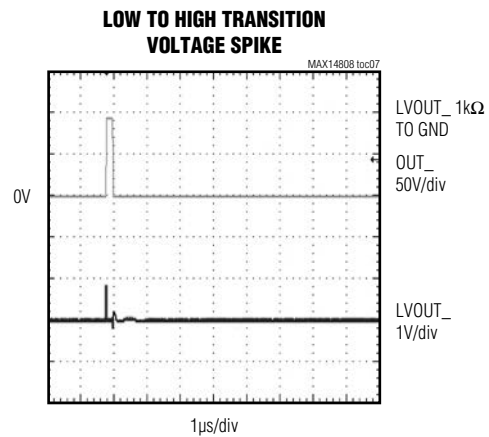
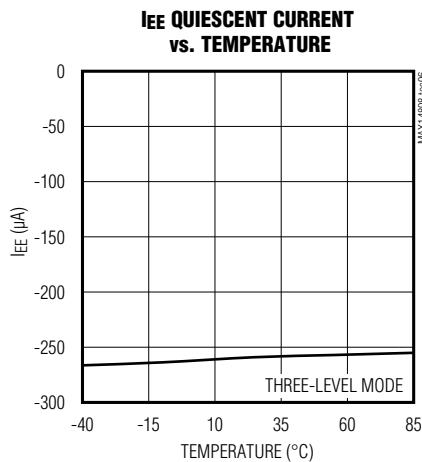
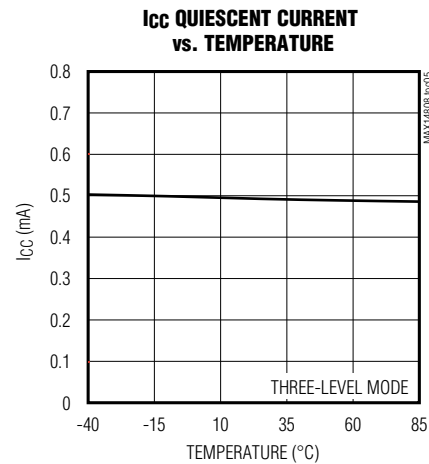
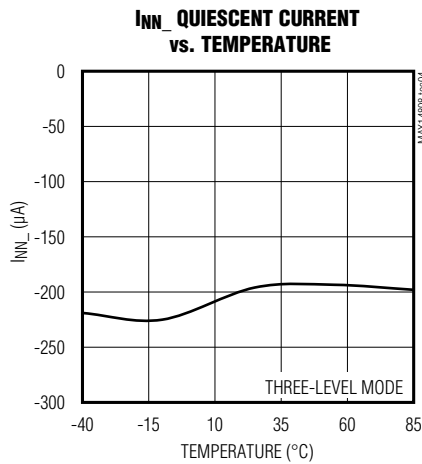


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Octal Three-Level/Quad Five-Level High-Voltage 2A Digital Pulsers with T/R Switch

Typical Operating Characteristics (continued)

($V_{DD} = +5V$, $V_{CC} = +5V$, $V_{EE} = -5V$, $V_{PP_} = +100V$, $V_{NN_} = -100V$, $R_L = 1k\Omega$, $C_L = 240pF$, unless otherwise noted. Typical values are at $T_A = +25^\circ C$.)

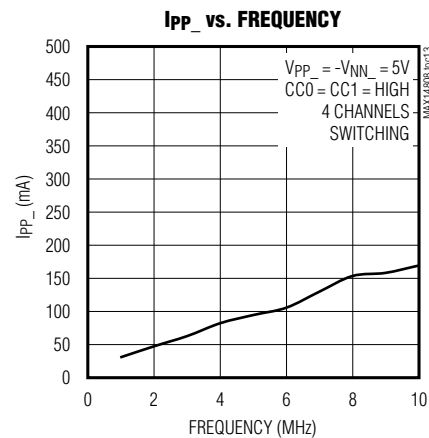
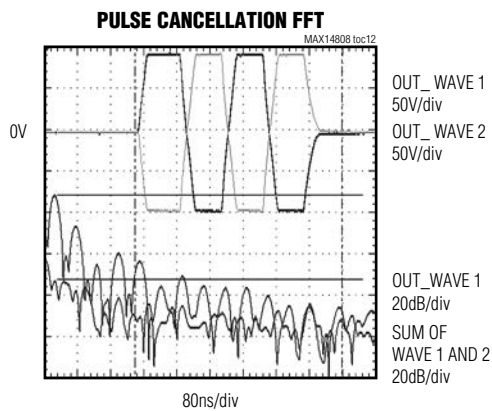
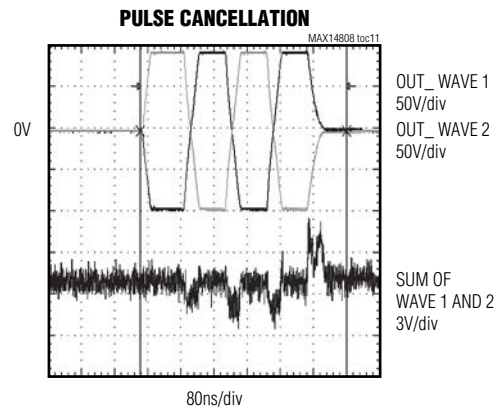
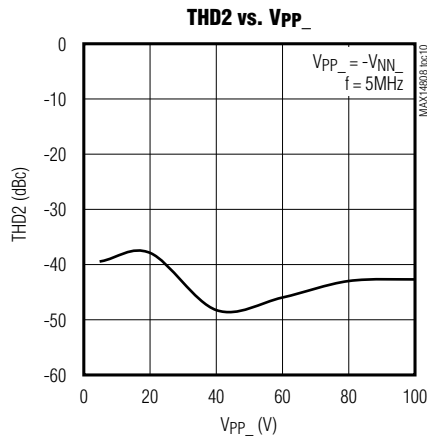


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Octal Three-Level/Quad Five-Level High-Voltage 2A Digital Pulsers with T/R Switch

Typical Operating Characteristics (continued)

($V_{DD} = +5V$, $V_{CC} = +5V$, $V_{EE} = -5V$, $V_{PP_} = +100V$, $V_{NN_} = -100V$, $R_L = 1k\Omega$, $C_L = 240pF$, unless otherwise noted. Typical values are at $T_A = +25^\circ C$.)

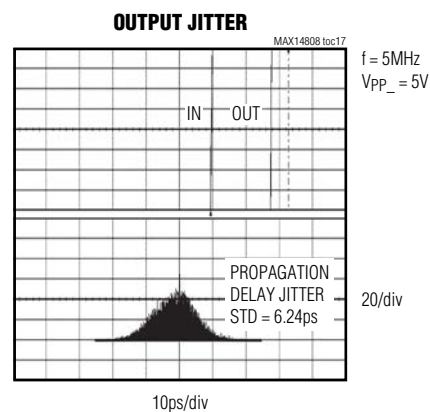
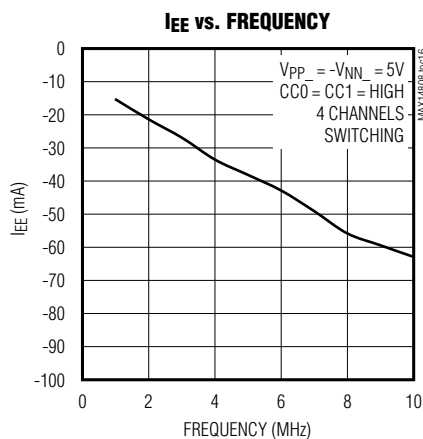
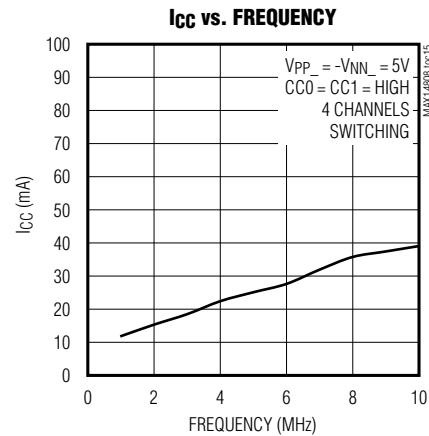
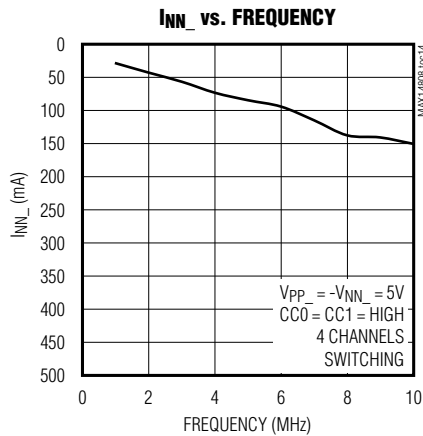


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Octal Three-Level/Quad Five-Level High-Voltage 2A Digital Pulsers with T/R Switch

Typical Operating Characteristics (continued)

($V_{DD} = +5V$, $V_{CC} = +5V$, $V_{EE} = -5V$, $V_{PP_} = +100V$, $V_{NN_} = -100V$, $R_L = 1k\Omega$, $C_L = 240pF$, unless otherwise noted. Typical values are at $T_A = +25^\circ C$.)

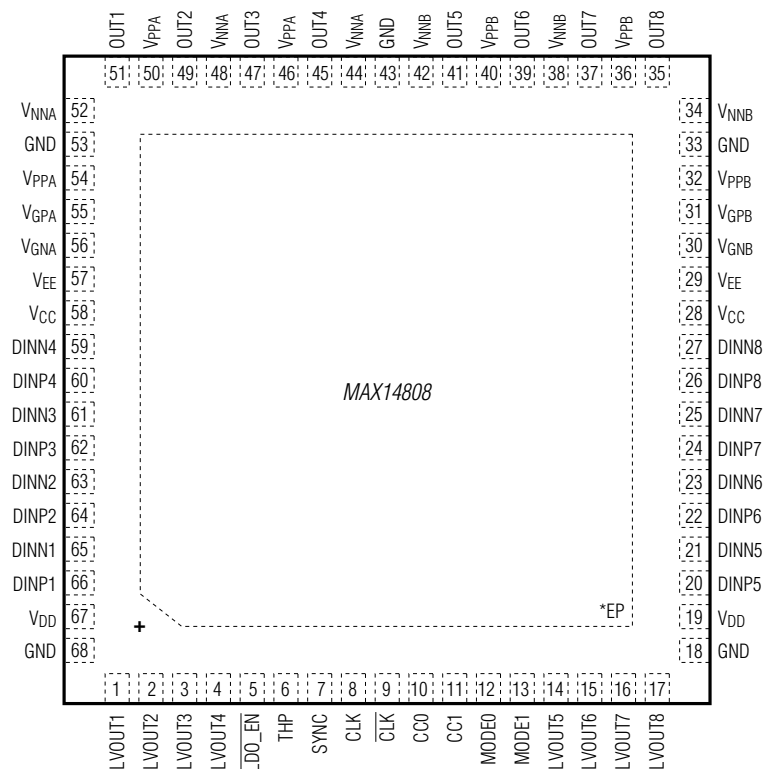


MAX14808/MAX14809

Octal Three-Level/Quad Five-Level High-Voltage 2A Digital Pulsers with T/R Switch

Pin Configurations

TOP VIEW



TQFN
(10mm x 10mm x 0.75mm)

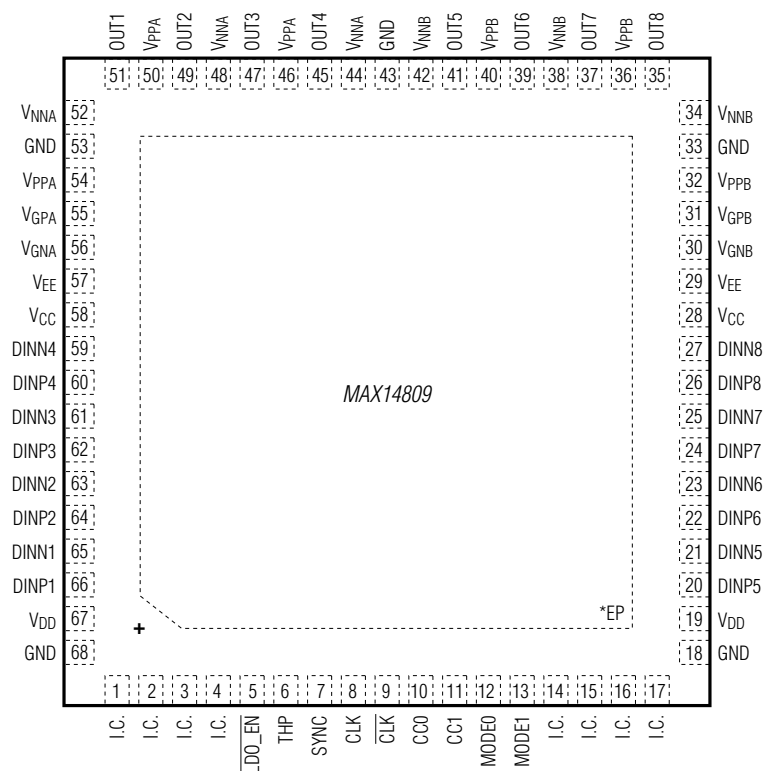
*CONNECT EP TO GND

MAX14808/MAX14809

Octal Three-Level/Quad Five-Level High-Voltage 2A Digital Pulsers with T/R Switch

Pin Configurations (continued)

TOP VIEW



TQFN
(10mm x 10mm x 0.75mm)

*CONNECT EP TO GND

MAX14808/MAX14809

Octal Three-Level/Quad Five-Level High-Voltage 2A Digital Pulsers with T/R Switch

Pin Description

PIN		NAME	FUNCTION
MAX14808	MAX14809		
1	—	LVOUT1	Low-Voltage T/R Switch Output 1
2	—	LVOUT2	Low-Voltage T/R Switch Output 2
3	—	LVOUT3	Low-Voltage T/R Switch Output 3
4	—	LVOUT4	Low-Voltage T/R Switch Output 4
—	1–4, 14–17	I.C.	Internally Connected. Connect I.C. to GND externally.
5	5	$\overline{\text{LDO_EN}}$	Internal Supply Generator Control Input. Drive $\overline{\text{LDO_EN}}$ high to disable the internal power supply when using an external power supply on V_{GPA} , V_{GPB} , V_{GNA} , and V_{GNB} . $\overline{\text{LDO_EN}}$ has an internal 10k Ω pulldown resistor to GND.
6	6	THP	Open-Drain Thermal-Protection Output. THP asserts and sinks a 3mA current to GND when the junction temperature exceeds +150°C.
7	7	SYNC	CMOS Control Input. Drive SYNC high to enable clocked-input mode. Drive SYNC low to operate in transparent mode (see the <i>Truth Tables</i> section).
8	8	CLK	CMOS Control Input. Clock positive phase input. Data inputs are clocked in at the rising edge of CLK and $\overline{\text{CLK}}$ in differential clocked mode or at the rising edge of CLK in single-ended clocked mode. Clock maximum frequency is 160MHz.
9	9	$\overline{\text{CLK}}$	CMOS Control Input. Clock negative phase input. Data inputs are clocked in at the edge of CLK and $\overline{\text{CLK}}$ in differential clocked mode. Clock maximum frequency is 160MHz. If $\overline{\text{CLK}}$ is connected to GND, the CLK input is a single-ended logic-level clock input. Otherwise, CLK and $\overline{\text{CLK}}$ are self-biased differential clock inputs.
10	10	CC0	Current Control Input. Control current capability (see the <i>Truth Tables</i> section).
11	11	CC1	Current Control Input. Control current capability (see the <i>Truth Tables</i> section).
12	12	MODE0	Mode Control Input. Control operation mode (see the <i>Truth Tables</i> section).
13	13	MODE1	Mode Control Input. Control operation mode (see the <i>Truth Tables</i> section).
14	—	LVOUT5	Low-Voltage T/R Switch Output 5
15	—	LVOUT6	Low-Voltage T/R Switch Output 6
16	—	LVOUT7	Low-Voltage T/R Switch Output 7
17	—	LVOUT8	Low-Voltage T/R Switch Output 8
18, 33, 43, 53, 68	18, 33, 43, 53, 68	GND	Ground
19, 67	19, 67	V_{DD}	Logic Supply Voltage. Bypass V_{DD} (both pins) to GND with a 0.1 μF capacitor as close as possible to the device.
20	20	DINP5	Digital Signal Positive Input 5 (see the <i>Truth Tables</i> section)
21	21	DINN5	Digital Signal Negative Input 5 (see the <i>Truth Tables</i> section)
22	22	DINP6	Digital Signal Positive Input 6 (see the <i>Truth Tables</i> section)
23	23	DINN6	Digital Signal Negative Input 6 (see the <i>Truth Tables</i> section)
24	24	DINP7	Digital Signal Positive Input 7 (see the <i>Truth Tables</i> section)
25	25	DINN7	Digital Signal Negative Input 7 (see the <i>Truth Tables</i> section)
26	26	DINP8	Digital Signal Positive Input 8 (see the <i>Truth Tables</i> section)
27	27	DINN8	Digital Signal Negative Input 8 (see the <i>Truth Tables</i> section)

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Octal Three-Level/Quad Five-Level High-Voltage 2A Digital Pulsers with T/R Switch

Pin Description (continued)

PIN		NAME	FUNCTION
MAX14808	MAX14809		
28, 58	28, 58	V _{CC}	V _{CC} Supply Voltage. Bypass V _{CC} (both pins) to GND with a 0.1μF capacitor as close as possible to the device.
29, 57	29, 57	V _{EE}	V _{EE} Supply Voltage. Bypass V _{EE} (both pins) to GND with a 0.1μF capacitor as close as possible to the device.
30	30	V _{GNB}	Driver Voltage Supply Output. Connect a 1μF capacitor to V _{NNB} as close as possible to the device.
31	31	V _{GPB}	Driver Voltage Supply Output. Connect a 1μF capacitor to V _{PPB} as close as possible to the device.
32, 36, 40	32, 36, 40	V _{PPB}	High-Voltage Positive Supply Input. Bypass V _{PPB} to GND with a 0.1μF capacitor as close as possible to the device.
34, 38, 42	34, 38, 42	V _{NNB}	High-Voltage Negative Supply Input. Bypass V _{NNB} to GND with a 0.1μF capacitor as close as possible to the device.
35	35	OUT8	Pulser Output 8
37	37	OUT7	Pulser Output 7
39	39	OUT6	Pulser Output 6
41	41	OUT5	Pulser Output 5
44, 48, 52	44, 48, 52	V _{NNA}	High-Voltage Negative Supply Input. Bypass V _{NNA} to GND with a 0.1μF capacitor as close as possible to the device.
45	45	OUT4	Pulser Output 4
46, 50, 54	46, 50, 54	V _{PPA}	High-Voltage Positive Supply Input. Bypass V _{PPA} to GND with a 0.1μF capacitor as close as possible to the device.
47	47	OUT3	Pulser Output 3
49	49	OUT2	Pulser Output 2
51	51	OUT1	Pulser Output 1
55	55	V _{GPA}	Driver Voltage Supply Output. Connect a 1μF capacitor to V _{PPA} as close as possible to the device.
56	56	V _{GNA}	Driver Voltage Supply Output. Connect a 1μF capacitor to V _{NNA} as close as possible to the device.
59	59	DINN4	Digital Signal Negative Input 4 (see the <i>Truth Tables</i> section)
60	60	DINP4	Digital Signal Positive Input 4 (see the <i>Truth Tables</i> section)
61	61	DINN3	Digital Signal Negative Input 3 (see the <i>Truth Tables</i> section)
62	62	DINP3	Digital Signal Positive Input 3 (see the <i>Truth Tables</i> section)
63	63	DINN2	Digital Signal Negative Input 2 (see the <i>Truth Tables</i> section)
64	64	DINP2	Digital Signal Positive Input 2 (see the <i>Truth Tables</i> section)
65	65	DINN1	Digital Signal Negative Input 1 (see the <i>Truth Tables</i> section)
66	66	DINP1	Digital Signal Positive Input 1 (see the <i>Truth Tables</i> section)
—	—	EP	Exposed Pad. Connect EP to GND. Not intended as an electrical connection point.

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Octal Three-Level/Quad Five-Level High-Voltage 2A Digital Pulsers with T/R Switch

Detailed Description

The MAX14808/MAX14809 octal three-level/quad five-level, high-voltage (HV) pulser devices generate high-frequency, HV bipolar pulses (up to $\pm 105\text{V}$) from low-voltage control logic inputs for driving piezoelectric transducers in ultrasound systems. All 8 channels have embedded overvoltage-protection diodes and integrated active return-to-zero clamp. Both devices have embedded independent (floating) power supplies (FPSs) and level shifters that allow signal transmission without the need for external HV capacitors. The MAX14808 also features eight integrated transmit receive (T/R) switches. The MAX14809 does not have the T/R switch function.

The devices feature two modes of operation, an octal three-level pulser mode (with integrated active return-to-zero clamp) or a quad five-level pulser mode. In octal three-level pulser mode, each channel is controlled by two logic inputs (DINN_/DINP_) and the active return to zero features half the current driving of the pulser, 1A (typ). In quad five-level pulser mode, each channel is controlled by three logic inputs and the active return to zero has the same current driving of the pulser, 2A (typ).

The devices can operate both in clocked and transparent mode. In clocked mode, data inputs can be synchronized with a clean differential or single-ended clock to reduce phase noise associated with FPGA output signals that are detrimental for Doppler analysis. In transparent mode, the synchronization feature is disabled and output reflects the data input after an 18ns delay. Both devices feature adjustable maximum current (0.5A to 2A) to reduce power consumption when full current capability is not required.

The devices feature integrated grass-clipping diodes (with low parasitic capacitance) for receive (Rx) and

transmit (Tx) isolations. Both devices feature a damping circuit that can be activated as soon as the transmit burst is over. The damping circuit has a typical on-resistance of 500Ω . It fully discharges the pulser's output internal node before the grass-clipping diodes.

Operation Mode

The devices have four operation modes: shutdown, octal three-level, quad five-level dual, and transmit disable. Use the MODE0 and MODE1 inputs to select the operation mode.

Shutdown Mode

All channels are disabled, no transmission and reception is possible. This mode has the lowest power consumption. See [Table 1](#).

Octal Three-Level Mode

The devices operate in eight independent channels. Each channel can generate a three-level pulse. The high-side and low-side FET of each channel are capable of providing 2.0A current, while the clamp is capable of 1A current. See [Table 2](#).

Quad Five-Level Dual Mode

The devices operate in four independent channels. Each channel can generate a five-level pulse. The devices feature independent dual-voltage supplies (V_{NNA} , V_{NNB} , V_{PPA} , and V_{PPB}) and can generate pulses among GND, V_{PPA} , and V_{NNA} or among GND, V_{PPB} , and V_{NNB} . The high-side and low-side FET as well as the clamp of each channel can provide 2.0A current. See [Table 3](#).

Transmit Disable Mode

All eight high-voltage transmit channels are disabled, no pulse transmission is possible. The T/R switch (MAX14808 only) can be turn-on (to receive low-voltage signals) or turn-off (for isolation). See [Table 4](#).

Truth Tables

Table 1. Shutdown Mode (MODE0 = Low, MODE1 = Low)

INPUTS		OUTPUTS	
DINN_	DINP_	OUT_	LVOUT_ (MAX14808 ONLY)
X	X	High impedance	High impedance (T/R switch off)

X = Don't care

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Truth Tables (continued)

Table 2. Octal Three-Level Mode (MODE0 = High, MODE1 = Low, $V_{NNA} = V_{NNB}$, $V_{PPA} = V_{PPB}$)

INPUTS		OUTPUTS	
DINN_	DINP_	OUT_	LVOUT_ (MAX14808 ONLY)
0	0	Clamp on (damp off)	T/R switch off (LVOUT_ = GND)
1	0	V_{NNA}/V_{NNB} (damp off)	T/R switch off (LVOUT_ = GND)
0	1	V_{PPA}/V_{PPB} (damp off)	T/R switch off (LVOUT_ = GND)
1	1	Clamp on (damp on)	T/R switch on

0 = logic-low, 1 = logic-high

Table 3. Quad Five-Level Dual Mode (MODE0 = Low, MODE1 = High)

INPUTS				OUTPUTS		
DINN _x x = 1, 2, 3, 4	DINP _x x = 1, 2, 3, 4	DINN _y y = 5, 6, 7, 8	DINP _y y = 5, 6, 7, 8	OUT _x = OUT _y	LVOUT _y y = 1, 2, 3, 4 (MAX14808 ONLY)	LVOUT _y y = 5, 6, 7, 8 (MAX14808 ONLY)
0	0	X	0	High impedance (damp off)	T/R switch off (LVOUT_ = GND)	T/R switch off (LVOUT_ = GND)
0	0	X	1	Clamp on (damp off)	T/R switch off (LVOUT_ = GND)	T/R switch off (LVOUT_ = GND)
0	1	0	X	V_{PPB} (damp off)	T/R switch off (LVOUT_ = GND)	T/R switch off (LVOUT_ = GND)
1	0	0	X	V_{NNB} (damp off)	T/R switch off (LVOUT_ = GND)	T/R switch off (LVOUT_ = GND)
0	1	1	X	V_{PPA} (damp off)	T/R switch off (LVOUT_ = GND)	T/R switch off (LVOUT_ = GND)
1	0	1	X	V_{NNA} (damp off)	T/R switch off (LVOUT_ = GND)	T/R switch off (LVOUT_ = GND)
1	1	1	X	Clamp on (damp on)	T/R switch on	T/R switch off

Note: Only three control inputs (DINN_x, DINP_x, DINN_y) are required for five-level, dual-mode operation. DINP_y can be connected to GND or VDD.

X = Don't care, 0 = logic-low, 1 = logic-high

Table 4. Transmit Disable Mode (MODE0 = High, MODE1 = High)

INPUTS		OUTPUTS	
DINN_	DINP_	OUT_	LVOUT_ (MAX14808 ONLY)
0	0	High impedance (damp off)	T/R switch off (LVOUT_ = GND)
1	0	High impedance (damp off)	T/R switch off (LVOUT_ = GND)
0	1	High impedance (damp off)	T/R switch off (LVOUT_ = GND)
1	1	High impedance (damp on)	T/R switch on

0 = logic-low, 1 = logic-high

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Current Capability Selection

The devices feature pulser current drive capability selection. Two control inputs (CC0, CC1) control the current drive capability ([Table 5](#)).

Sync Function

The devices provide the ability to resynchronize all the data inputs by means of a clean clock signal. In ultrasound systems, the FPGA output signals are often affected by a high jitter. The jitter induces phase noise that is detrimental in Doppler analysis. The input clock

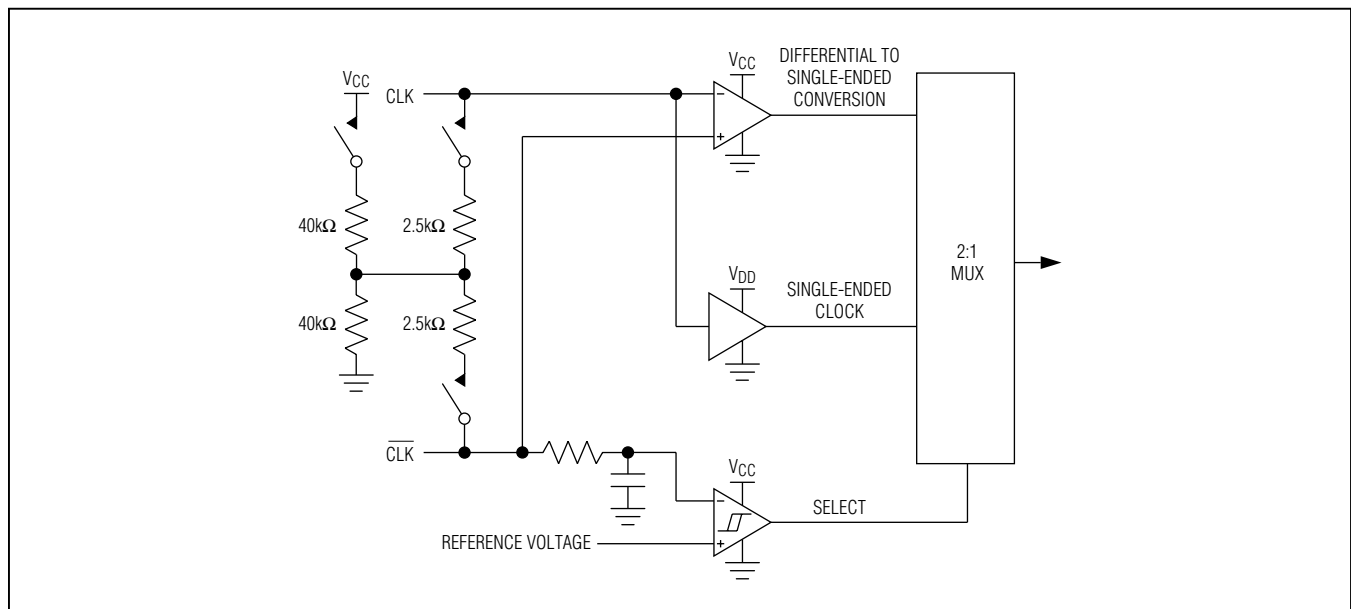
can be either a differential signal or a single-ended signal running up to 160MHz. Data are clocked in on the rising edge of the CLK input (falling edge of $\overline{\text{CLK}}$). Connect $\overline{\text{CLK}}$ to GND for single-ended operation. The sync feature can be enabled or disabled by the SYNC control input. Drive the SYNC input low to disable the synchronization function (no external clock signal). Drive the SYNC input high to enable the synchronization function (with an external clock signal). [Figure 6](#) shows the simplified CLK and $\overline{\text{CLK}}$ inputs schematic.

T/R Switches (MAX14808 Only)

Each channel features a low-power T/R switch. The T/R switch recovery time after the transmission is less than 1.2μs. The T/R switches are controlled by the same pulser digital inputs (see the [Truth Tables](#) section). No dedicated input signals are required to activate/deactivate the T/R switches. The integrated T/R switches do not require any special timings and can operate synchronously with the digital pulser. To minimize the leakage current during transmission, it's recommended to switch off the T/R switches 3μs before the beginning of the transmit burst.

Table 5. Current Drive Selection

INPUTS		PULSER OUTPUT CURRENT (typ)
CC0	CC1	
0	0	2A
1	0	1.5A
0	1	1A
1	1	0.5A

Figure 6. Simplified CLK and $\overline{\text{CLK}}$ Inputs Schematic

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Grass-Clipping Diodes

A pair of diodes in antiparallel configuration (referred to as grass-clipping diodes) is presented at each pulser's output. The diodes' reverse capacitance is extremely low, allowing a perfect isolation between the receive path and the actual pulser's output stage.

Active Damp Circuit

An active damp circuit is integrated between the internal pulser output node (before grass-clipping diodes) and GND. The purpose of this circuit is to fully discharge the pulser output internal node so that the node is not left in high-impedance condition as soon as the transmit burst is over. This results in two main advantages:

- 1) The grass-clipping isolation is more effective.
- 2) Suppression of any low-frequency oscillation of a node that could be detrimental for Doppler mode performances.

Independent (Floating) Power-Supply Enable (LDO_EN)

The devices feature the $\overline{\text{LDO_EN}}$ control input to enable/disable the internal FPSs. This allows the usage of external high-efficiency power supplies to save system power. This option must be considered only for special applications requiring extremely low power dissipation. The low power dissipation of the embedded FPSs already meets power requirements in most of the cases. Drive $\overline{\text{LDO_EN}}$ low or leave unconnected to enable the internal FPSs; drive $\overline{\text{LDO_EN}}$ high to disable the internal FPSs.

Thermal Warning Outputs

The devices feature an open-drain thermal-protection output (THP). When the internal junction temperature exceeds +150°C, the devices automatically enter shut-down mode and THP asserts. The devices reenter normal operation and the THP deasserts when the die temperature drops below +130°C.

Power Sequencing

When using the embedded FPSs ($\overline{\text{LDO_EN}}$ = low), the devices do not require any power-up/power-down sequence. When external FPSs are used ($\overline{\text{LDO_EN}}$ = high), the conditions $\text{VGP}_- > (\text{VEE} - 0.6\text{V})$ and $\text{VGN}_- < (\text{VCC} + 0.6\text{V})$ must be satisfied during the entire power-up/power-down transients (see the electrical characteristics tables).

Applications Information

Exposed Pad and Layout Concerns

The devices provide an exposed pad (EP) underneath the TQFN package for improved thermal performance. Connect EP to GND externally and do not run traces under the package to avoid possible short circuits. To aid heat dissipation, connect EP to a similarly sized pad on the component side of the PCB. This pad should be connected through to the solder-side copper by several plated holes to a large heat-spreading copper area to conduct heat away from the device.

The devices' high-speed pulser requires low-inductance bypass capacitors to their supply inputs. High-speed PCB trace design practices are recommended. Pay particular attention to minimize trace lengths and use sufficient trace width to reduce inductance. Use of surface-mount components is recommended.

Typical Application Circuit

Figure 7 shows the MAX14808 in an octal three-level pulsing application.

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Octal Three-Level/Quad Five-Level High-Voltage 2A Digital Pulsers with T/R Switch

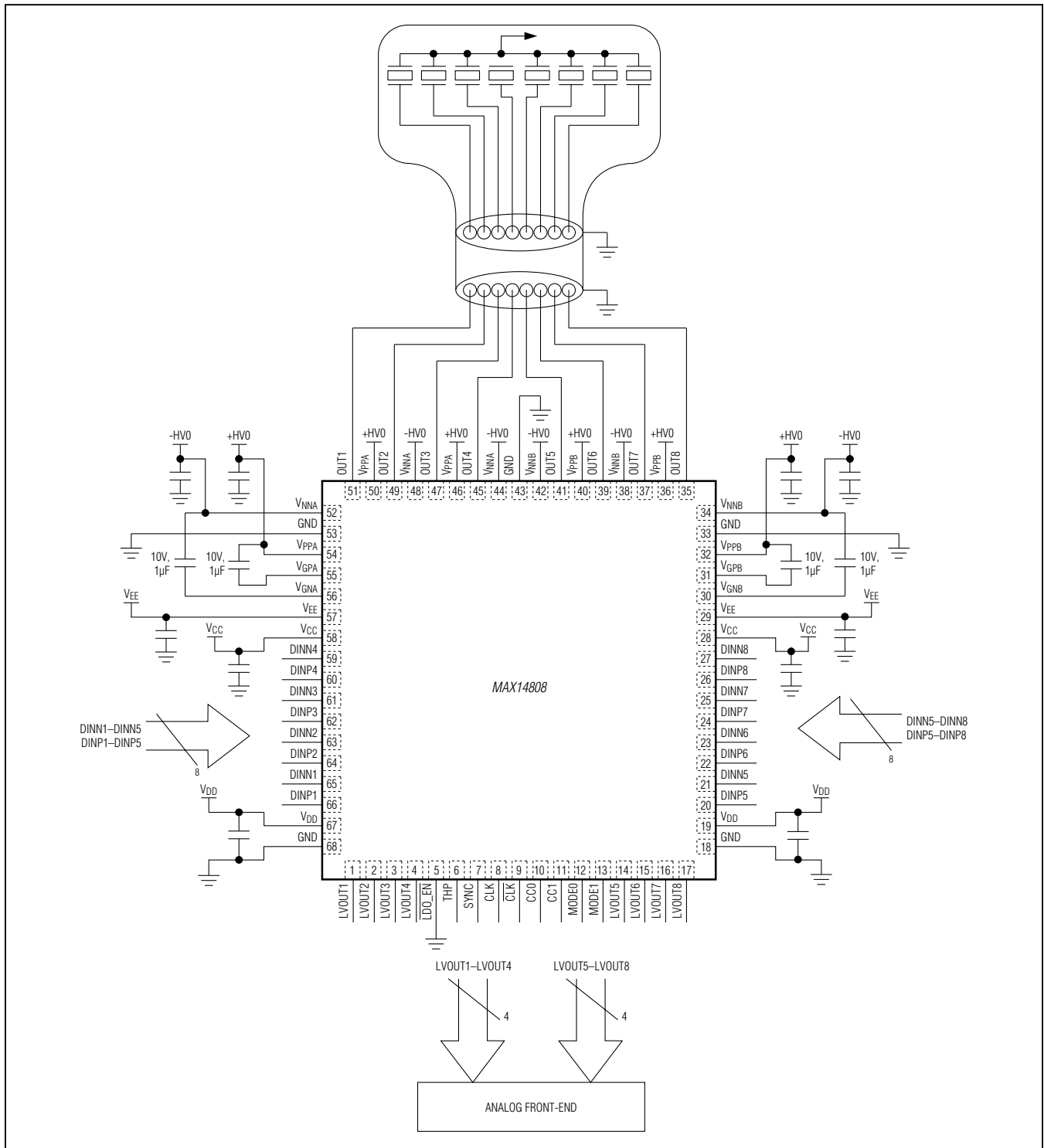
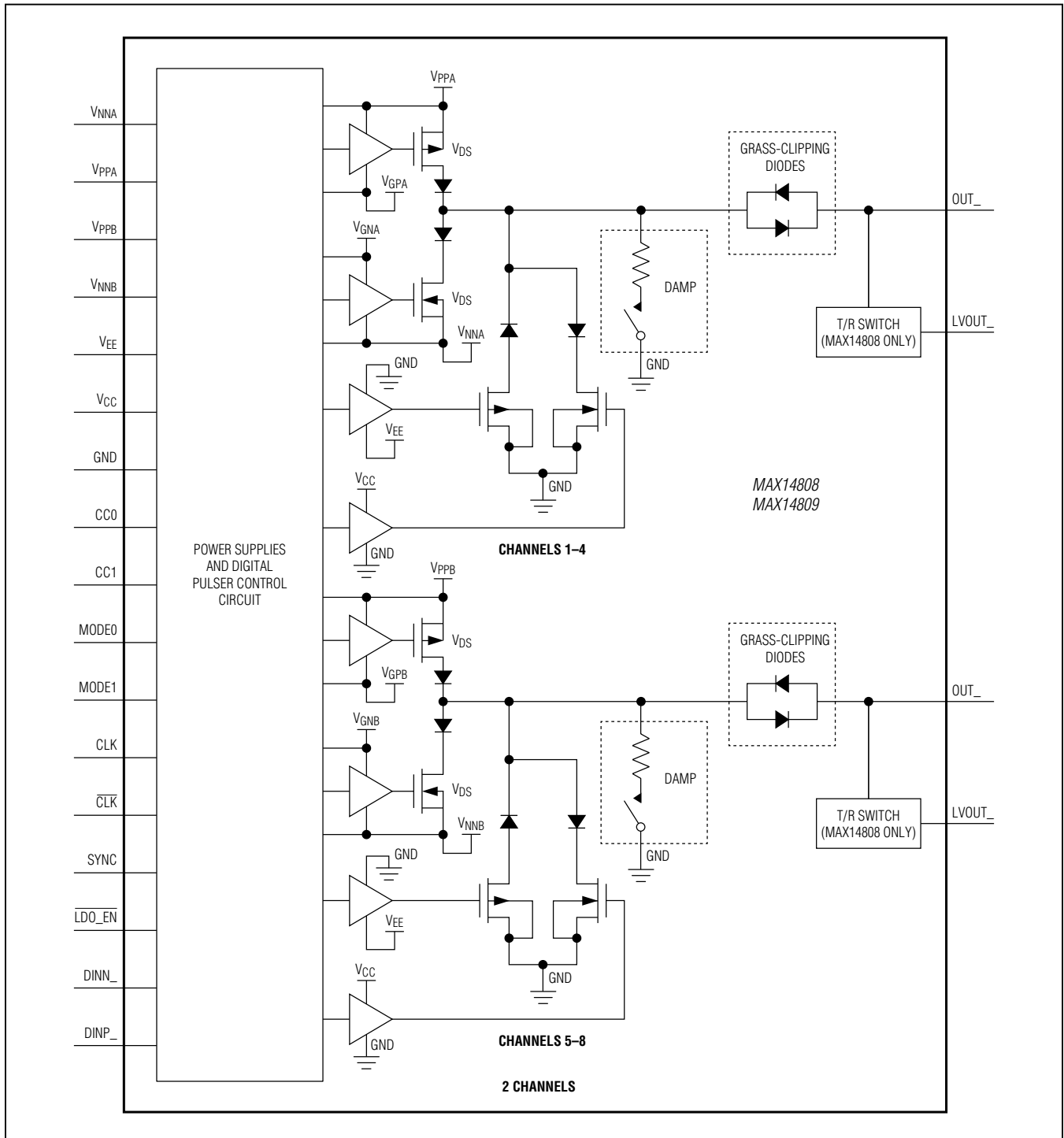


Figure 7. Octal Three-Level Pulsing (MAX14808)

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Octal Three-Level/Quad Five-Level High-Voltage 2A Digital Pulsers with T/R Switch

Functional Diagram



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Octal Three-Level/Quad Five-Level High-Voltage 2A Digital Pulsers with T/R Switch

Ordering Information

PART	TRANSMIT CHANNELS	T/R SWITCHES	TEMP RANGE	PIN-PACKAGE
MAX14808ETK+	Yes	Yes	-40°C to +85°C	68 TQFN-EP*
MAX14809ETK+	Yes	No	-40°C to +85°C	68 TQFN-EP*

+Denotes a lead(Pb)-free/RoHS-compliant package.

*EP = Exposed pad.

Chip Information

PROCESS: BiCMOS

Package Information

For the latest package outline information and land patterns (footprints), go to www.maximintegrated.com/packages. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

PACKAGE TYPE	PACKAGE CODE	OUTLINE NO.	LAND PATTERN NO.
68 TQFN-EP	T6800+4	21-0142	90-0101

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Revision History

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
0	9/12	Initial release	—
1	3/13	Updated the <i>DC Electrical Characteristics</i> and <i>AC Electrical Characteristics</i> tables; updated TOC 9 in the <i>Typical Operating Characteristics</i> section; removed the future product notation from the MAX14809 in the <i>Ordering Information</i> table	5–8, 11, 17, 30
2	1/14	Updated the <i>DC Electrical Characteristics</i> and <i>AC Electrical Characteristics</i> tables	8, 9, 11



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